

# Digital Monitor Module System



## High-Density Configuration

This uniquely designed dual chassis features two separate compartments, each accommodating up to eight modules mounted horizontally. The two compact compartments are mounted side-by-side in a specially designed dual-column 600 mm rack.

This high-density configuration allows a total of 352 circuits in one rack.

Cable management bars and four vertical cabling ducts ensure proper routing for high-density cabling.

### Features

- Improved circuit density by 20%; 352 circuits in fully loaded bay
- Cable bars reduce cable congestion and simplify maintenance
- Circuit designation label door ensures proper cable routing and identification
- Bay equipped with four vertical cabling channels, cable troughs, and equipment cable tie-down bars for high-density cable management
- Zone 4 earthquake-rated equal-flange rack with EIA mounting spacing



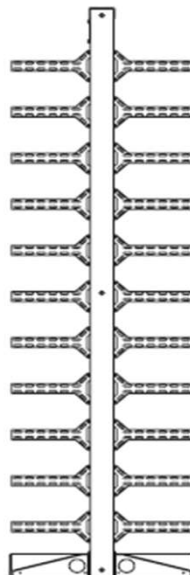
D3C-0016HD  
Front View

### Ordering Information

Description	Dimensions (HxWxD)	Catalog Number
Unloaded Pair of Dual Chassis Accommodates up to 16 modules in two, eight-position chassis	88 x 236 x 165 mm (3.5" x 9.3" x 6.5")	D3C-0016HD
600 mm Dual Skeleton Bay Accommodates up to 11 dual chassis	2200 x 600 x 250 mm (86.7" x 23.6" x 23.6")	IBC-D3C001



IBC-D3001  
Front View



IBC-D3001  
Side View